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Vishay Siliconix

RoHS

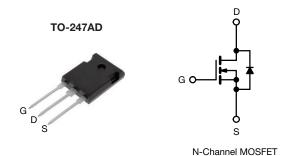
COMPLIANT

HALOGEN

FREE

EF Series Power MOSFET with Fast Body Diode

PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	650				
R _{DS(on)} max. at 25 °C (Ω)	V _{GS} = 10 V	0.065			
Q _g max. (nC)	228				
Q _{gs} (nC)	32				
Q _{gd} (nC)	62				
Configuration	Single				



FEATURES

- Fast body diode MOSFET using E series technology
- Reduced t_{rr}, Q_{rr}, and I_{RRM}
- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (Ciss)
- Increased robustness due to low Q_{rr}
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishav.com/doc?99912</u>

APPLICATIONS

- Telecommunications
 - Server and telecom power supplies
- Lighting
 - High-intensity lighting (HID)
 - Light emitting diodes (LEDs)
- Consumer and computing
 - ATX power supplies
- Industrial
 - Welding
- Battery chargers
- · Renewable energy
- Solar (PV inverters)
- Switching mode power supplies (SMPS)
- · Applications using the following topologies
 - LLC
 - Phase shifted bridge (ZVS)
 - 3-level inverter
 - AC/DC bridge

ORDERING INFORMATION	
Package	TO-247AD
Lead (Pb)-free and Halogen-free	SiHW47N60EF-GE3

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V_{DS}	600	V	
Gate-Source Voltage			V _{GS}	± 30	V	
Continuous Drain Current (T,I = 150 °C)	V _{GS} at 10 V	T _C = 25 °C		47	A	
Continuous Drain Current (1) = 150 C)		T _C = 100 °C	I _D	29		
Pulsed Drain Current ^a			I _{DM}	138		
Linear Derating Factor				3	W/°C	
Single Pulse Avalanche Energy b			E _{AS}	1500	mJ	
Maximum Power Dissipation			P _D	379	W	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +150	°C	
Drain-Source Voltage Slope	T _J = 125 °C		d)//d+	70	1//	
Reverse Diode dV/dt d			dV/dt	50	- V/ns	
Soldering Recommendations (Peak Temperature) c for 10 s			300	°C		

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. $V_{DD} = 50 \text{ V}$, starting $T_J = 25 \,^{\circ}\text{C}$, $L = 73.5 \,^{\circ}\text{mH}$, $R_g = 25 \,^{\circ}\Omega$, $I_{AS} = 6.4 \,^{\circ}\text{A}$
- c. 1.6 mm from case
- d. $I_{SD} \le I_D$, dl/dt = 500 A/ μ s, starting T_J = 25 °C



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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-	40	°C/W	
Maximum Junction-to-Case (Drain)	R_{thJC}	-	0.33		

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static		-		·	·	·	
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		600	-	-	٧
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 1 mA	-		-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	V _{GS} , I _D = 250 μA	2.0	-	4.0	٧
	2.5(1.4)	\	$I_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA
Gate-Source Leakage	I_{GSS}		$I_{GS} = \pm 30 \text{ V}$	-	-	± 1	μA
			480 V, V _{GS} = 0 V	-	-	1	μΑ
Zero Gate Voltage Drain Current	I_{DSS}		, V _{GS} = 0 V, T _J = 125 °C	-	-	500	
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V		-	0.056	0.065	Ω
Forward Transconductance	9fs		= 30 V, I _D = 24 A	-	17	-	S
Dynamic							
Input Capacitance	C _{iss}	$V_{GS} = 0 \text{ V},$ $V_{DS} = 100 \text{ V},$ f = 1 MHz		-	5000	-	pF
Output Capacitance	Coss			-	220	-	
Reverse Transfer Capacitance	C _{rss}			-	7	-	
Effective Output Capacitance, Energy Related ^a	C _{o(er)}			-	172	-	
Effective Output Capacitance, Time Related ^b	C _{o(tr)}	$V_{DS} = 0.0$	/ to 480 V, V _{GS} = 0 V	-	634	-	
Total Gate Charge	Qg			-	152	228	
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	$I_D = 24 \text{ A}, V_{DS} = 480 \text{ V}$	-	32	-	nC
Gate-Drain Charge	Q_{gd}			-	62	-	
Turn-On Delay Time	$t_{d(on)}$			-	30	60	
Rise Time	t _r	$V_{DD} = 480 \text{ V}, I_D = 24 \text{ A},$		-	56	84	ns
Turn-Off Delay Time	$t_{d(off)}$	V _{GS} =	$V_{GS} = 10 \text{ V}, R_g = 4.4 \Omega$		91	137	
Fall Time	t _f			-	56	84	
Gate Input Resistance	R_{g}	f = 1 MHz, open drain		0.2	0.46	1.0	Ω
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	47	
Pulsed Diode Forward Current	I _{SM}			-	-	138	A
Diode Forward Voltage	V _{SD}	T _J = 25 °C	C, I _S = 24 A, V _{GS} = 0 V	-	0.9	1.2	V
Body Diode Reverse Recovery Time	t _{rr}	T _J = 25 °C, I _F = I _{S = 24 A} , dI/dt = 100 A/ μ s, V _R = 400 V		-	199	398	ns
Body Diode Reverse Recovery Charge	Q _{rr}			-	1.4	2.8	μC
Reverse Recovery Current	I _{RRM}			_	13.2	_	Α

Notes

- a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}
- b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

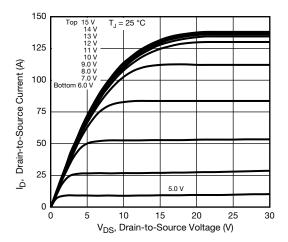


Fig. 1 - Typical Output Characteristics

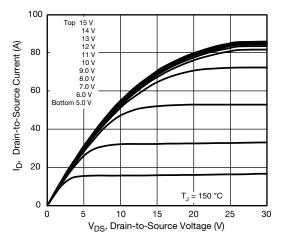


Fig. 2 - Typical Output Characteristics

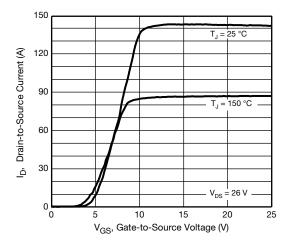


Fig. 3 - Typical Transfer Characteristics

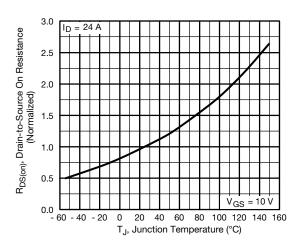


Fig. 4 - Normalized On-Resistance vs. Temperature

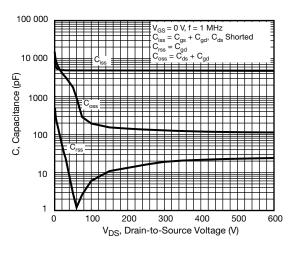


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

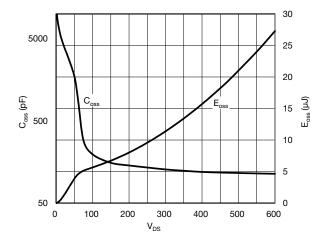


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}



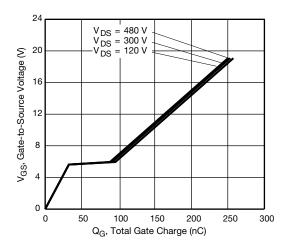


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

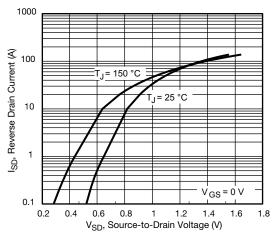


Fig. 8 - Typical Source-Drain Diode Forward Voltage

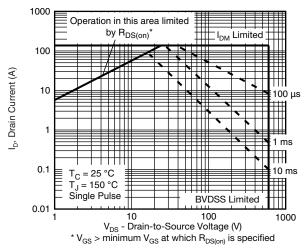


Fig. 9 - Maximum Safe Operating Area

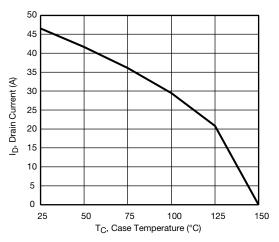


Fig. 10 - Maximum Drain Current vs. Case Temperature

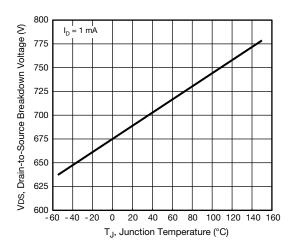


Fig. 11 - Temperature vs. Drain-to-Source Voltage



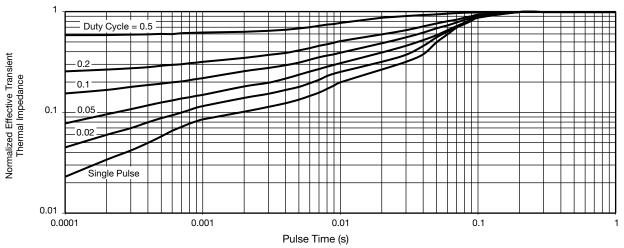


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

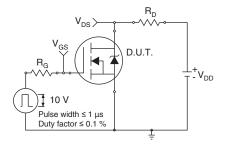


Fig. 13 - Switching Time Test Circuit

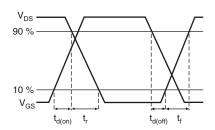


Fig. 14 - Switching Time Waveforms

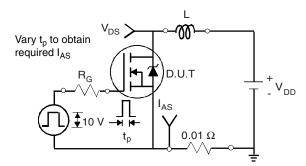


Fig. 15 - Unclamped Inductive Test Circuit

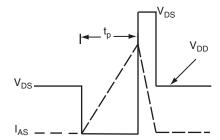


Fig. 16 - Unclamped Inductive Waveforms

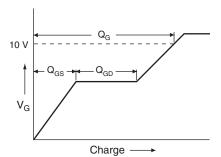


Fig. 17 - Basic Gate Charge Waveform

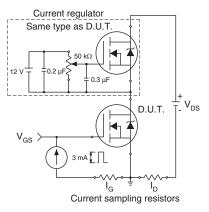
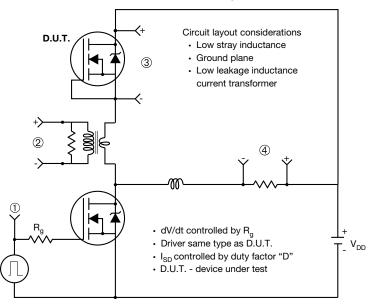


Fig. 18 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



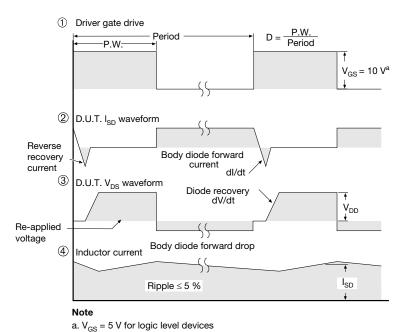
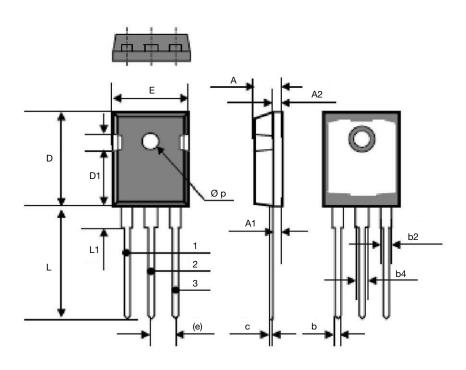


Fig. 18 - For N-Channel

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TO-247AD (High Voltage)



DIM.	MILLIM	IETERS	INCHES		
	MIN.	MAX.	MIN.	MAX.	
Α	4.70	5.31	0.185	0.209	
A1	2.21	2.59	0.087	0.102	
A2	1.50	2.49	0.059	0.098	
b	0.99	1.40	0.039	0.055	
b2	1.65	2.41	0.065	0.095	
b4	2.59	3.43	0.102	0.135	
С	0.61 BSC		0.024 BSC		
D	20.80	21.46	0.819	0.845	
D1	3.68	5.49	0.145	0.216	
(e)	5.46 BSC		0.215	BSC	
Е	15.49	16.26	0.610	0.640	
L	19.81	20.32	0.780	0.800	
L1	4.06	4.50	0.160	0.177	
Øр	3.51	3.66	0.138	0.144	

ECN: S17-0178-Rev. B, 06-Feb-17

DWG: 6010



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